#### TOSHIBA BI-DIRECTIONAL TRIODE THYRISTOR SILICON PLANAR TYPE

# SM16GZ47,SM16JZ47,SM16GZ47A,SM16JZ47A

#### AC POWER CONTROL APPLICATIONS

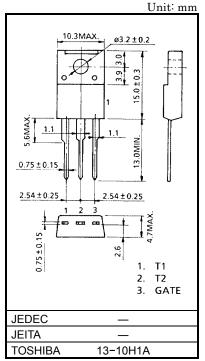
Repetitive Peak Off-State Voltage : V<sub>DRM</sub> = 400, 600V
 R.M.S On-State Current : I<sub>T</sub> (RMS) = 16A

• High Commutating (dv / dt)

• Isolation Voltage : VISOL = 1500V AC

#### **MAXIMUM RATINGS**

CHARACTER	ISTIC	SYMBOL	RATING	UNIT	
Repetitive Peak	SM16GZ47 SM16GZ47A	V	400	V	
Off-State Voltage	SM16JZ47 SM16JZ47A	$V_{DRM}$	600		
R.M.S On-State Currer (Full Sine Waveform To		I <sub>T (RMS)</sub>	16	А	
Peak One Cycle Surge On-State Current (Non-Repetitive)		I <sub>TSM</sub>	150 (50Hz)	А	
			165 (60Hz)		
I <sup>2</sup> t Limit Value		I <sup>2</sup> t	112.5	A <sup>2</sup> s	
Critical Rate of Rise of Current	On-State (Note 1)	di / dt	50	A / µs	
Peak Gate Power Dissi	pation	$P_{GM}$	5	W	
Average Gate Power D	issipation	P <sub>G (AV)</sub>	0.5	W	
Peak Gate Voltage		$V_{GM}$	10	V	
Peak Gate Current		I <sub>GM</sub>	2	Α	
Junction Temperature		Tj	-40~125	°C	
Storage Temperature F	lange	T <sub>stg</sub>	-40~125	°C	
Isolation Voltage (AC, t	= 1 min.)	V <sub>ISOL</sub>	1500	V	



Weight: 1.7g

Note 1: di / dt Test condition  $V_{DRM} = 0.5 \times Rated$   $I_{TM} \le 25A$   $t_{gw} \ge 10 \mu s$   $t_{gr} \le 250 ns$ 

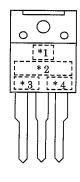
 $i_{GP} = I_{GT} \times 2.0$ 



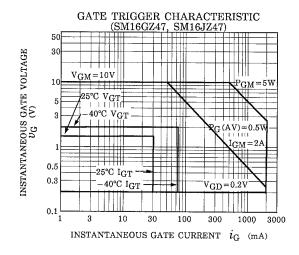
## **ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

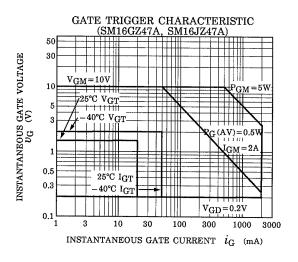
CHARACTERISTIC		SYMBOL	TEST CONDITION		MIN	TYP.	MAX	UNIT		
Repetitive Peak	Off-Sta	te Current		I <sub>DRM</sub>	V <sub>DRM</sub> = Rated		_	_	20	μA
		I		V <sub>D</sub> = 12V, R <sub>L</sub> = 20Ω	T2 (+) , Gate (+)		_	1.5	V	
		II			T2 (+) , Gate (-)	_	_	1.5		
		Ш			T2 (-) , Gate (-)	_	_	1.5		
		IV			T2 (-) , Gate (+)	_	_	_		
			I			T2 (+) , Gate (+)	_	_	30	
Gate Trigger Current SM	SM16	SM16GZ47				T2 (+) , Gate (-)	-	_	30	
	SM16	SM16JZ47	III		$V_D = 12V$ , $R_L = 20\Omega$	T2 (-) , Gate (-)	_	_	30	mA
			IV	lgт		T2 (-) , Gate (+)	-	_	_	
		SM16GZ47A SM16JZ47A	I			T2 (+) , Gate (+)	_	_	20	
	SM16		II			T2 (+) , Gate (-)		_	20	
	SM16		III			T2 (-) , Gate (-)	_	_	20	
						T2 (-) , Gate (+)	_	_	_	1
Peak On-State Voltage		$V_{TM}$	I <sub>TM</sub> = 25A			_	1.5	V		
Gate Non-Trigger Voltage		V <sub>GD</sub>	V <sub>D</sub> = Rated, Tc = 125°C		0.2	_	_	V		
Holding Current		lΗ	V <sub>D</sub> = 12V, I <sub>TM</sub> = 1A		_	_	50	mA		
Thermal Resistance		R <sub>th (j-c)</sub>	Junction to Case, AC		-	_	2.5	°C/W		
Critical Rate of Rise of Off-State Voltage	SM16GZ4 <sup>2</sup> SM16JZ47		dv / dt	V <sub>DRM</sub> = Rated, T <sub>j</sub> = 125°C Exponential Rise		_	300	_	- V / µs	
	SM16GZ4 <sup>2</sup> SM16JZ47		av / at			_	200	_		
Critical Rate of Rise of		SM16GZ4 <sup>2</sup> SM16JZ47		(dy / dt) c	V <sub>DRM</sub> = 400V, T <sub>i</sub> = 125°C		10	_	_	V/us
		SM16GZ4 SM16JZ47		(dv / dt) c	$V_{DRM} = 400V, T_j = 125^{\circ}C$ (di / dt) c = -8.7A / ms		4	_	_	V/µs

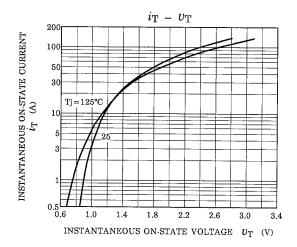
### **MARKING**

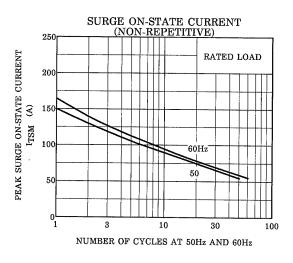


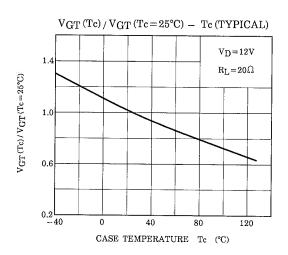
* NUMBER	SYMBOL		MARK	
* 1	Toshiba Product Mark		7	
* 2		SM16GZ47, SM16GZ47A	M16GZ47	
2	TYPE	SM16JZ47, SM16JZ47A	M16JZ47	
* 3		SM16GZ47A, SM16JZ47A	A	
* 4	Lot Number  Month (Starting from Alphabet A)  Year (Last Decimal Digit) of the Current Year)		Example 8A : January 1998 8B : February 1998 8L : December 1998	

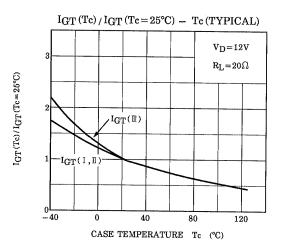




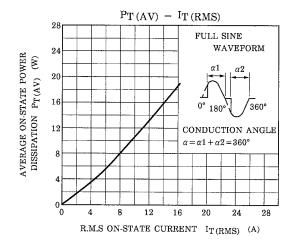


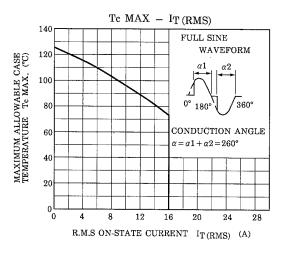


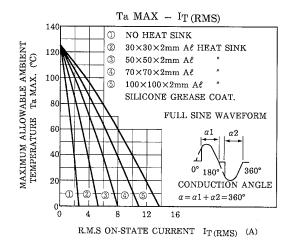


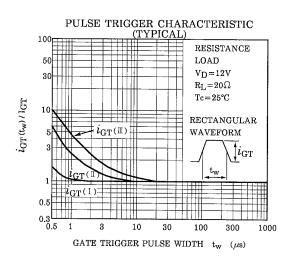


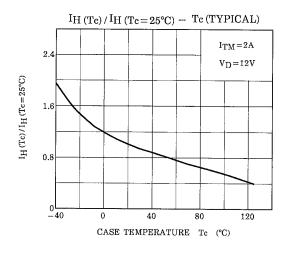
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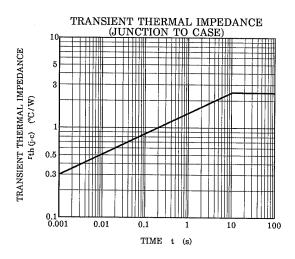












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